## 1. General description

Planar Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a SOD123W small and flat lead Surface-Mounted Device (SMD) plastic package.

### 2. Features and benefits

- Average forward current: I<sub>F(AV)</sub> ≤ 1 A
- Reverse voltage: V<sub>R</sub> ≤ 60 V
- · Extremely low leakage current
- · Low forward voltage
- High power capability due to clip-bonding technology
- · Small and flat lead SMD plastic package
- High temperature T<sub>i</sub> ≤ 175 °C
- Qualified according to AEC-Q101 and recommended for use in automotive applications

# 3. Applications

- · Low voltage rectification
- High efficiency DC-to-DC conversion
- · Switch mode power supply
- · Reverse polarity protection

### 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 170 °C	-	-	1	Α
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C	-	-	60	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	605	660	mV
I <sub>R</sub>	reverse current	$V_R = 60 \text{ V}; t_p \le 300  \mu\text{s}; \delta \le 0.02;$ $T_j = 25 ^{\circ}\text{C}; \text{ pulsed}$	-	90	300	nA

# 5. Pinning information

**Table 2. Pinning information** 

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode[1]	1 2	К <del>_<b>[</b>&lt;</del> ]-А
2	А	anode	CFP3 (SOD123W)	sym001

[1] The marking bar indicates the cathode.



# 6. Ordering information

#### **Table 3. Ordering information**

Type number	Package							
	Name	Description	Version					
PMEG6010ELR-Q	CFP3	plastic, surface mounted package; 2 terminals; 2.6 mm x 1.7 mm x 1 mm body	SOD123W					

# 7. Marking

#### Table 4. Marking codes

Type number	Marking code
PMEG6010ELR-Q	K1

# 8. Limiting values

### Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>R</sub>	reverse voltage	T <sub>j</sub> = 25 °C		-	60	V
I <sub>F</sub>	forward current	δ = 1; T <sub>sp</sub> = 165 °C		-	1.41	А
I <sub>F(AV)</sub>	average forward current	$\delta$ = 0.5; f = 20 kHz; square wave; T <sub>sp</sub> $\leq$ 170 °C		-	1	A
l		$\delta$ = 0.5; f = 20 kHz; square wave; $T_{amb} \le$ 140 °C	[1]	-	1	Α
I <sub>FSM</sub>	non-repetitive peak forward current	$t_p$ = 8.3 ms; half sine wave; $T_{j(init)}$ = 25 °C		-	50	А
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[2]	-	680	mW
			[3]	-	1.15	W
			[1]	-	2.14	W
Tj	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

<sup>[1]</sup> Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.

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<sup>2]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

<sup>[3]</sup> Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

## 9. Thermal characteristics

**Table 6. Thermal characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from		[1] [2]	-	-	220	K/W
	junction to ambient		[1] [3]	-	-	130	K/W
			[1] [4]	-	-	70	K/W
R <sub>th(j-sp)</sub>	thermal resistance from junction to solder point		[5]	-	-	18	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses P<sub>R</sub> are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.
- [4] Device mounted on a ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint.
- [5] Soldering point of cathode tab.

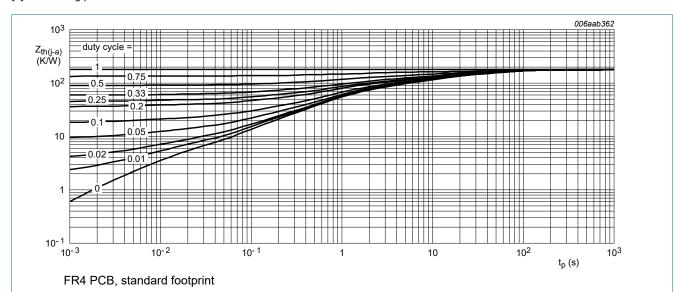


Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

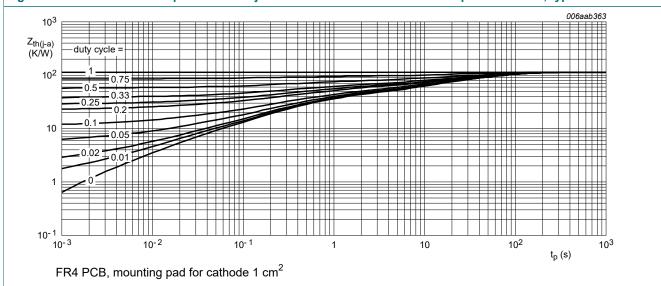
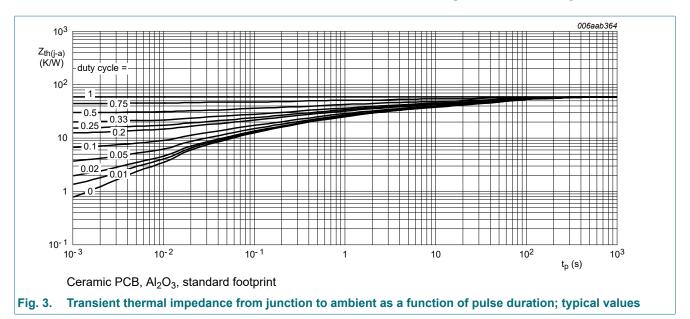


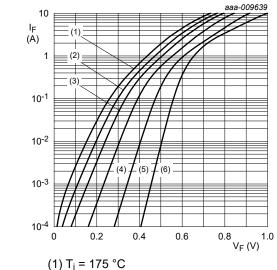
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



## 10. Characteristics

**Table 7. Characteristics** 

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I <sub>R</sub> = 1 mA; T <sub>j</sub> = 25 °C	60	-	-	V
V <sub>F</sub>	forward voltage	I <sub>F</sub> = 0.1 A; T <sub>j</sub> = 25 °C	-	475	540	mV
		I <sub>F</sub> = 0.5 A; T <sub>j</sub> = 25 °C	-	550	605	mV
		I <sub>F</sub> = 0.7 A; T <sub>j</sub> = 25 °C	-	575	625	mV
		I <sub>F</sub> = 1 A; T <sub>j</sub> = 25 °C	-	605	660	mV
I <sub>R</sub>	reverse current	$V_R = 5 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	5	-	nA
		$V_R = 10 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 25 \text{ °C; pulsed}$	-	6	-	nA
		$V_R = 40 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 25 ^\circ\text{C; pulsed}$	-	25	50	nA
		$V_R = 60 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 25 ^\circ\text{C; pulsed}$	-	90	300	nA
		$V_R = 10 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 125 \text{ °C; pulsed}$	-	25	-	μΑ
		$V_R = 60 \text{ V; } t_p \le 300  \mu\text{s; } \delta \le 0.02;$ $T_j = 125 \text{ °C; pulsed}$	-	120	-	μΑ
C <sub>d</sub>	diode capacitance	V <sub>R</sub> = 1 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	110	-	pF
		V <sub>R</sub> = 4 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	65	-	pF
		V <sub>R</sub> = 10 V; f = 1 MHz; T <sub>j</sub> = 25 °C	-	45	-	pF
t <sub>rr</sub>	reverse recovery time	$I_F = 0.5 \text{ A}$ ; $I_R = 0.5 \text{ A}$ ; $I_{R(meas)} = 0.1 \text{ A}$ ; $I_{j} = 25 \text{ °C}$	-	4.5	-	ns
$V_{FRM}$	peak forward recovery voltage	$I_F = 0.5 \text{ A}$ ; $dI_F/dt = 20 \text{ A/}\mu\text{s}$ ; $T_j = 25 \text{ °C}$	-	580	-	mV



(2)  $T_i = 150 °C$ 

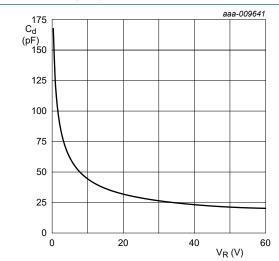
(3)  $T_i = 125 °C$ 

 $(4) T_i = 85 ^{\circ}C$ 

 $(5) T_i = 25 ^{\circ}C$ 

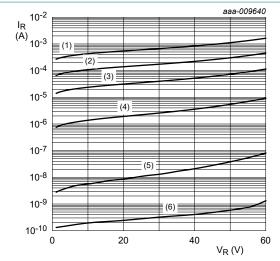
(6)  $T_i = -40 \, ^{\circ}\text{C}$ 

Fig. 4. Forward current as a function of forward voltage; typical values



 $f = 1 \text{ MHz}; T_{amb} = 25 ^{\circ}\text{C}$ 

Fig. 6. Diode capacitance as a function of reverse voltage; typical values



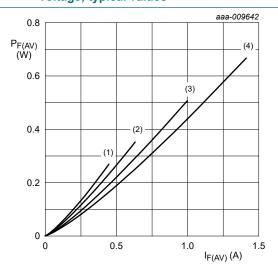
(1)  $T_j = 175 \,^{\circ}\text{C}$ (2)  $T_j = 150 \,^{\circ}\text{C}$ 

(3)  $T_i' = 125 °C$ 

 $(4) T_i = 85 ^{\circ}C$ 

 $(5) T_i = 25 ^{\circ}C$ (6)  $T_i = -40 \,^{\circ}\text{C}$ 

Fig. 5. Reverse current as a function of reverse voltage; typical values



T<sub>i</sub> = 175 °C

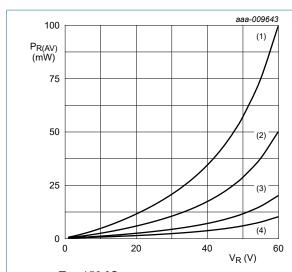
 $(1) \delta = 0.1$ 

 $(2) \delta = 0.2$ 

 $(3) \delta = 0.5$  $(4) \delta = 1$ 

Fig. 7. Average forward power dissipation as a function of average forward current; typical

values



 $T_j = 150 \, ^{\circ}C$ 

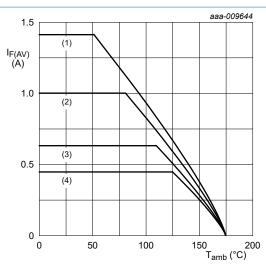
 $(1) \delta = 1$ 

 $(2) \delta = 0.5$ 

 $(3) \delta = 0.2$ 

 $(4) \delta = 0.1$ 

Fig. 8. Average reverse power dissipation as a function of reverse voltage; typical values



FR4 PCB, standard footprint

T<sub>i</sub> = 175 °C

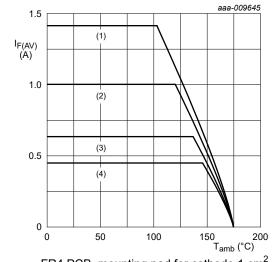
 $(1) \delta = 1 (DC)$ 

(2)  $\delta = 0.5$ ; f = 20 kHz

 $(3) \delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm<sup>2</sup>

 $T_i = 175 \,{}^{\circ}\text{C}$ 

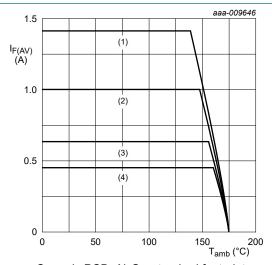
 $(1) \delta = 1 (DC)$ 

(2)  $\delta$  = 0.5; f = 20 kHz

(3)  $\delta = 0.2$ ; f = 20 kHz

(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 10. Average forward current as a function of ambient temperature; typical values



Ceramic PCB, Al<sub>2</sub>O<sub>3</sub>, standard footprint

 $T_i = 175 \,{}^{\circ}\text{C}$ 

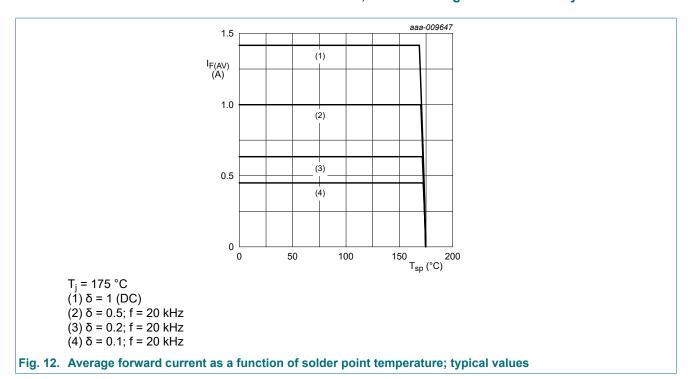
 $(1) \delta = 1 (DC)$ 

 $(2) \delta = 0.5$ ; f = 20 kHz

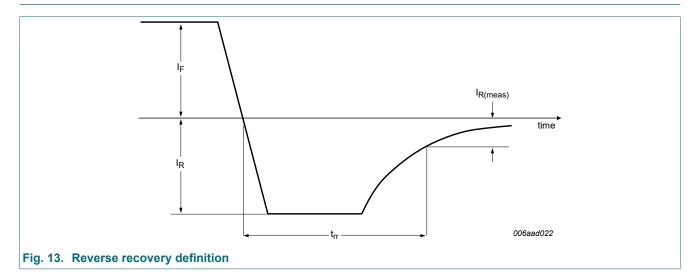
(3)  $\delta = 0.2$ ; f = 20 kHz

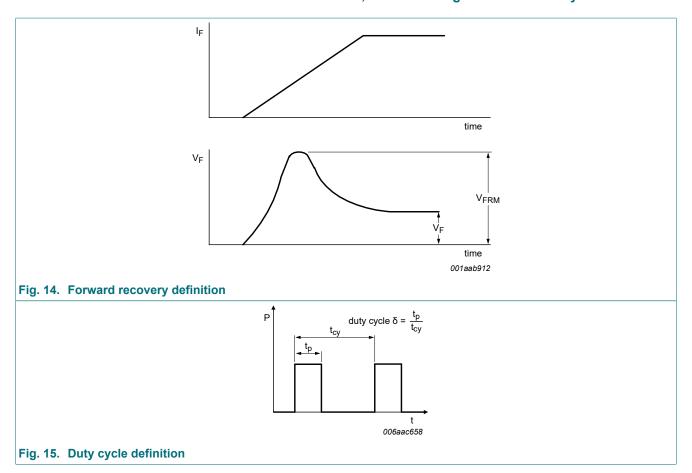
(4)  $\delta = 0.1$ ; f = 20 kHz

Fig. 11. Average forward current as a function of ambient temperature; typical values



# 11. Test information





The current ratings for the typical waveforms are calculated according to the equations:

 $I_{F(AV)} = I_M \times \delta$  with  $I_M$  defined as peak current,

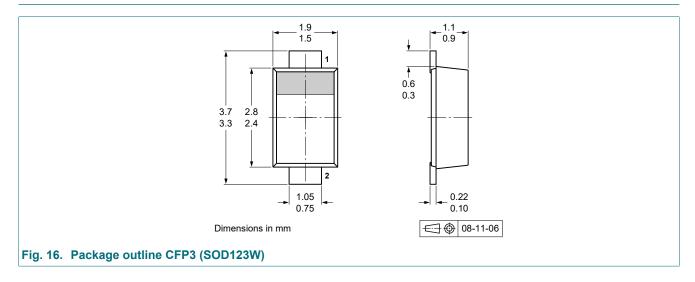
 $I_{RMS} = I_{F(AV)}$  at DC,

 $I_{RMS} = I_{M} \times \sqrt{\delta}$  with  $I_{RMS}$  defined as RMS current.

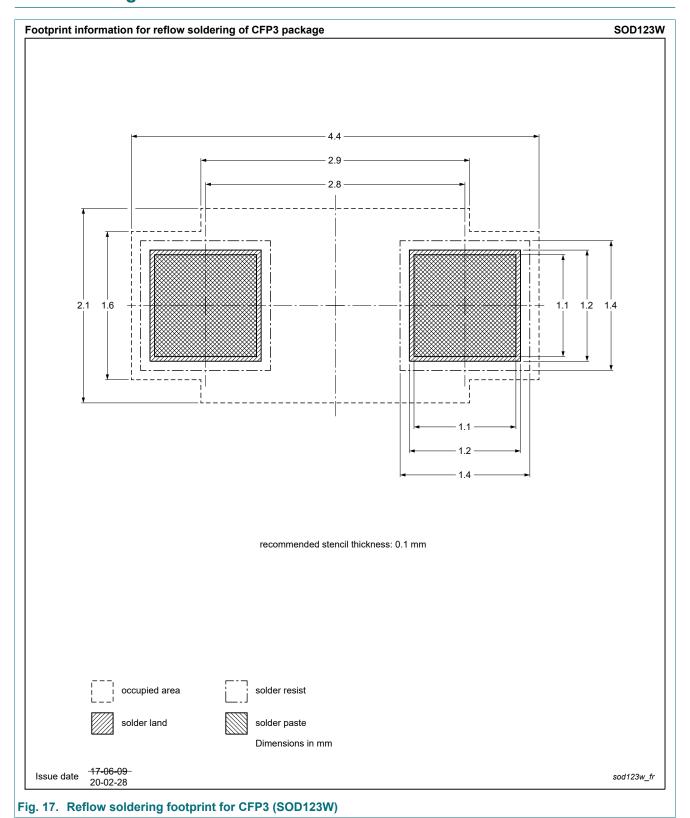
### **Quality information**

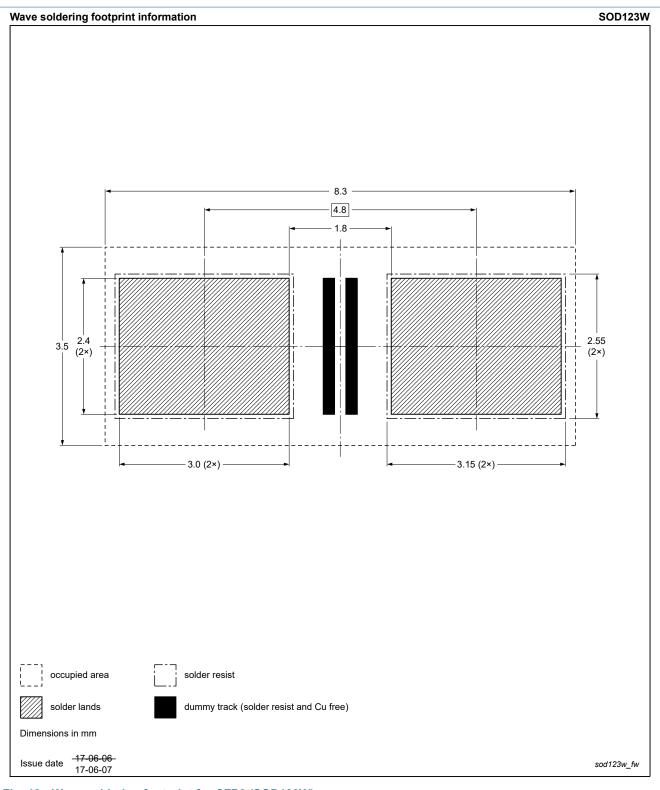
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

# 12. Package outline



# 13. Soldering





# 14. Revision history

#### **Table 8. Revision history**

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes					
PMEG6010ELR-Q v.2	20221116	Product data sheet	-	PMEG6010ELR-Q v.1					
Modifications:	Limiting values: Mea wave.	Limiting values: Measurement conditions for I <sub>FSM</sub> changed from square wave to half-sine wave.							
PMEG6010ELR-Q v.1	20210511	Product data sheet	-	-					

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## 15. Legal information

#### **Data sheet status**

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- Please consult the most recently issued document before initiating or completing a design.
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